



## **Product Content Sheet**

Package family	TSSOP	Picture of typical product, optional
Date	28/Sep/2006	
Version	RoHS	

Composition part	Material group	Materials	CAS if applicable	Average mass [weight-%] *)	Sum [%]	Traces
Chip	Silicon and inorganic	Si	7440-21-3	100	4.794588	-
Wires	compounds Nobel Metal	Gold	7440-57-5	99.99	0.251362	-
Leadframe	Alloy	Copper	7440-50-8	95.256483	31.514138	-
		Silicon	7440-21-3	0.643625	0.212933	-
		Nickel	7440-02-0	2.970576	0.982769	-
		Magnesium	7439-95-4	0.148529	0.049139	-
		Silver	7440-22-4	0.980787	0.324478	-
Mold compound	Silica and thermoset epoxy resin	Si fused	60676-86-0	86.91	48.316472	-
		Epoxy & Phenol resin	Confidential	12.78	7.104873	-
		Carbon Black	1333-86-4	0.31	0.172340	-
DA Epoxy	Ероху	Silver	7440-22-4	75	2.690103	-
		Epoxy Resin	Confidential	10	0.358680	-
		Gamma Butyrolactone	96-48-0	5	0.179340	-
		Amine	Confidential	5	0.179340	-
		Metal Oxide	Confidential	5	0.179340	
Leadfinish	Metal Alloy	Sn	7440-31-5	100	2.690103	
Marking	Laser	Laser	-	-	-	-
	l	L	1	Sum in total:	100	-

Weight range	0.112189 g
Fluctuation margin	~10%

Case sizes\*\*) and weight range

Not part of package fan	nily	
Company	Texas Instruments Norway	Important remarks:

Company	Texas Instruments Norway	
Address	Gaustadalleen 21, 0349 Oslo, Norway	
Support	http://www-k.ext.ti.com/sc/technical- support/pic/euro.htm	
Internet	www.ti.com	

- Traces are product parts, substances etc. that are below a percentage of 0.1 % by weight. Higher limits are accepted if the substance or material is legally regulated (see note no. 2).
- A list of the (legal) "... restrictions on substances ..." or materials is available at internet address:
  - http://www.eicta.org/Content/Default.asp?PageID=113.
    Substances, materials etc. with possible harmful effects on
- 3) human beings and the environment are listed.

or:

<sup>\*)</sup> related to package weight; weight in particular, see corresponding *package weight list*\*\*) optional



- There are no risks for human beings and to the environment if products are properly used as designated.
   This shall not apply to risks caused during procedures for disposal etc.
- All statements herein are based on our present knowledge.
   If our products are used properly, there are no risks to human beings and/or the environment.



## **Package Weight List**

(Single weights of Products, materials data see Product Content Sheet on previous page)

Package family	TSSOP
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	Uspec short*)	Package family*)	Package	Internal package code	Pin count	Weight [grams]	Remark
			9.7x4.4x0.9 TSSOP	TSSOP 28	28		Device: CC1000
L							

<sup>\*)</sup> USpec short name and Package family are optional, e.g. for summary of several package weight lists

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